

V_{DRM}	=	4500 V
I_{TGQM}	=	4000 A
I_{TSM}	=	25×10^3 A
V_{T0}	=	1.2 V
r_T	=	0.65 mW
V_{Dclink}	=	2800 V

Asymmetric Gate turn-off Thyristor 5SGF 40L4502

Doc. No. 5SYA1209-04 Feb. 05

- Patented free-floating silicon technology
- Low on-state and switching losses
- Annular gate electrode
- Industry standard housing
- Cosmic radiation withstand rating

Blocking

Maximum rated values ¹⁾

Parameter	Symbol	Conditions	min	typ	max	Unit
Repetitive peak off-state voltage	V_{DRM}	$V_{GR} \geq 2$ V			4500	V
Repetitive peak reverse voltage	V_{RRM}				17	V
Permanent DC voltage for 100 FIT failure rate	V_{Dclink}	Ambient cosmic radiation at sea level in open air.			2800	V

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Repetitive peak off-state current	I_{DRM}	$V_D = V_{DRM}$, $V_{GR} \geq 2$ V			100	mA
Repetitive peak reverse current	I_{RRM}	$V_R = V_{RRM}$, $R_{GK} = \infty \Omega$			50	mA

Mechanical data

Maximum rated values ¹⁾

Parameter	Symbol	Conditions	min	typ	max	Unit
Mounting force	F_m		36	40	44	kN

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Pole-piece diameter	D_p	± 0.1 mm		75		mm
Housing thickness	H		26.0		26.5	mm
Weight	m				1.5	kg
Surface creepage distance	D_s	Anode to Gate	33			mm
Air strike distance	D_a	Anode to Gate	14			mm

1) Maximum rated values indicate limits beyond which damage to the device may occur

ABB Switzerland Ltd, Semiconductors reserves the right to change specifications without notice.



GTO Data

On-state

Maximum rated values ¹⁾

Parameter	Symbol	Conditions	min	typ	max	Unit
Max. average on-state current	$I_{T(AV)M}$	Half sine wave, $T_C = 85^\circ\text{C}$			1180	A
Max. RMS on-state current	$I_{T(RMS)}$				1850	A
Max. peak non-repetitive surge current	I_{TSM}	$t_p = 10\text{ ms}$, $T_{vj} = 125^\circ\text{C}$, sine wave After Surge: $V_D = V_R = 0\text{ V}$			25×10^3	A
Limiting load integral	I^2t				3.1×10^6	A^2s
Max. peak non-repetitive surge current	I_{TSM}	$t_p = 1\text{ ms}$, $T_{vj} = 125^\circ\text{C}$, sine wave After Surge: $V_D = V_R = 0\text{ V}$			40×10^3	A
Limiting load integral	I^2t				800×10^3	A^2s

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
On-state voltage	V_T	$I_T = 4000\text{ A}$, $T_{vj} = 125^\circ\text{C}$			3.8	V
Threshold voltage	$V_{(T0)}$	$T_{vj} = 125^\circ\text{C}$ $I_T = 400 \dots 5000\text{ A}$			1.2	V
Slope resistance	r_T				0.65	$\text{m}\Omega$
Holding current	I_H	$T_{vj} = 25^\circ\text{C}$			100	A

Turn-on switching

Maximum rated values ¹⁾

Parameter	Symbol	Conditions	min	typ	max	Unit
Critical rate of rise of on-state current	di_T/dt_{cr}	$T_{vj} = 125^\circ\text{C}$, $f = 200\text{ Hz}$ $I_T = 4000\text{ A}$, $I_{GM} = 50\text{ A}$, $di_G/dt = 40\text{ A}/\mu\text{s}$, $f = 1\text{ Hz}$			500	$\text{A}/\mu\text{s}$
Critical rate of rise of on-state current	di_T/dt_{cr}				1000	$\text{A}/\mu\text{s}$
Min. on-time	t_{on}		100			μs

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Turn-on delay time	t_d	$V_D = 0.5 V_{DRM}$, $T_{vj} = 125^\circ\text{C}$ $I_T = 4000\text{ A}$, $di/dt = 300\text{ A}/\mu\text{s}$, $I_{GM} = 50\text{ A}$, $di_G/dt = 40\text{ A}/\mu\text{s}$, $C_S = 6\text{ }\mu\text{F}$, $R_S = 5\text{ }\Omega$			2.5	μs
Rise time	t_r				5	μs
Turn-on energy per pulse	E_{on}				3	J

Turn-off switching

Maximum rated values ¹⁾

Parameter	Symbol	Conditions	min	typ	max	Unit
Max. controllable turn-off current	I_{TGQM}	$V_{DM} \leq V_{DRM}$, $di_{GQ}/dt = 40\text{ A}/\mu\text{s}$, $C_S = 6\text{ }\mu\text{F}$, $L_S \leq 0.2\text{ }\mu\text{H}$			4000	A
Min. off-time	t_{off}		100			μs

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Storage time	t_s	$V_D = 0.5 V_{DRM}$, $T_{vj} = 125^\circ\text{C}$ $V_{DM} \leq V_{DRM}$, $di_{GQ}/dt = 40\text{ A}/\mu\text{s}$, $I_{TGQ} = I_{TGQM}$, $R_S = 5\text{ }\Omega$, $C_S = 6\text{ }\mu\text{F}$, $L_S = 0.2\text{ }\mu\text{H}$			25	μs
Fall time	t_f				3	μs
Turn-on energy per pulse	E_{off}				10	J
Peak turn-off gate current	I_{GQM}				1100	A

Gate

Maximum rated values ¹⁾

Parameter	Symbol	Conditions	min	typ	max	Unit
Repetitive peak reverse voltage	V _{GRM}				17	V
Repetitive peak reverse current	I _{GRM}	V _{GR} = V _{GRM}			20	mA

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Gate trigger voltage	V _{GT}	T _{vj} = 25°C,		1.2		V
Gate trigger current	I _{GT}	V _D = 24 V, R _A = 0.1 Ω		4		A

Thermal

Maximum rated values ¹⁾

Parameter	Symbol	Conditions	min	typ	max	Unit
Junction operating temperature	T _{vj}		-40		125	°C
Storage temperature range	T _{stg}		-40		125	°C

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Thermal resistance junction to case	R _{th(jc)}	Double side cooled			11	K/kW
	R _{th(jc)A}	Anode side cooled			20	K/kW
	R _{th(jc)C}	Cathode side cooled			25	K/kW
Thermal resistance case to heatsink (Double side cooled)	R _{th(ch)}	Single side cooled			6	K/kW
	R _{th(ch)}	Double side cooled			3	K/kW

Analytical function for transient thermal impedance:

$$Z_{thJC}(t) = \sum_{i=1}^n R_i(1 - e^{-t/\tau_i})$$

i	1	2	3	4
R _i (K/kW)	7.766	1.728	1.064	0.450
τ _i (s)	0.5764	0.1258	0.0128	0.0031

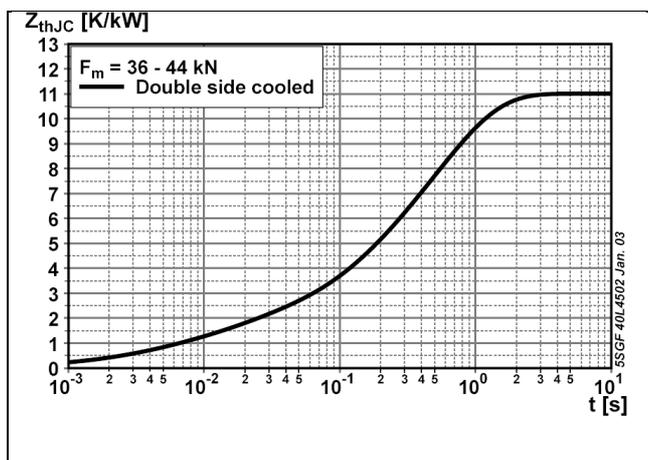


Fig. 1 Transient thermal impedance, junction to case.

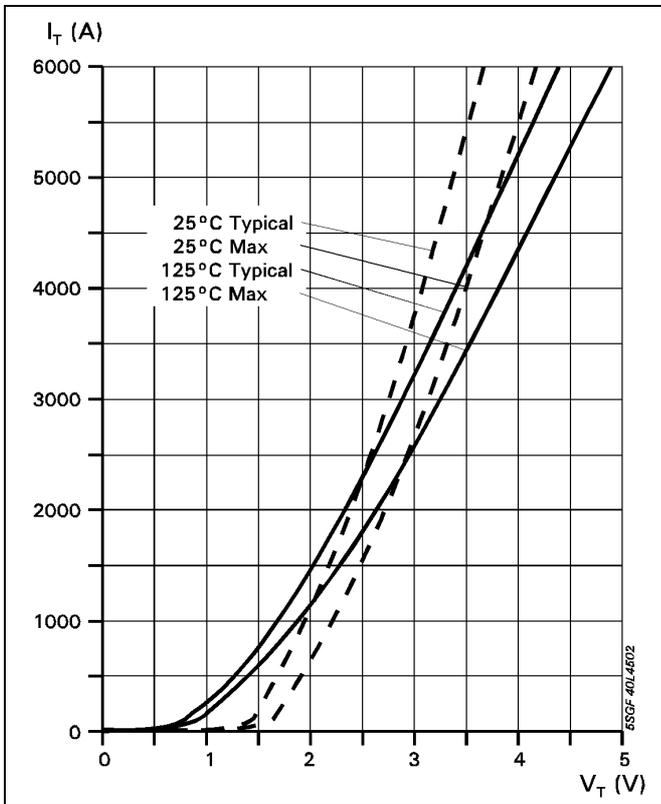


Fig. 2 On-state characteristics.

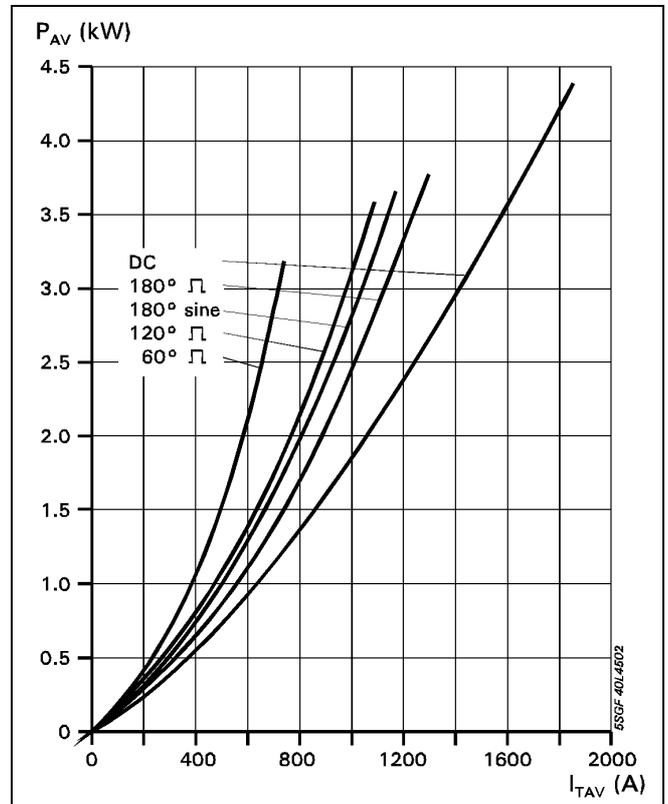


Fig. 3 Average on-state power dissipation vs. average on-state current.

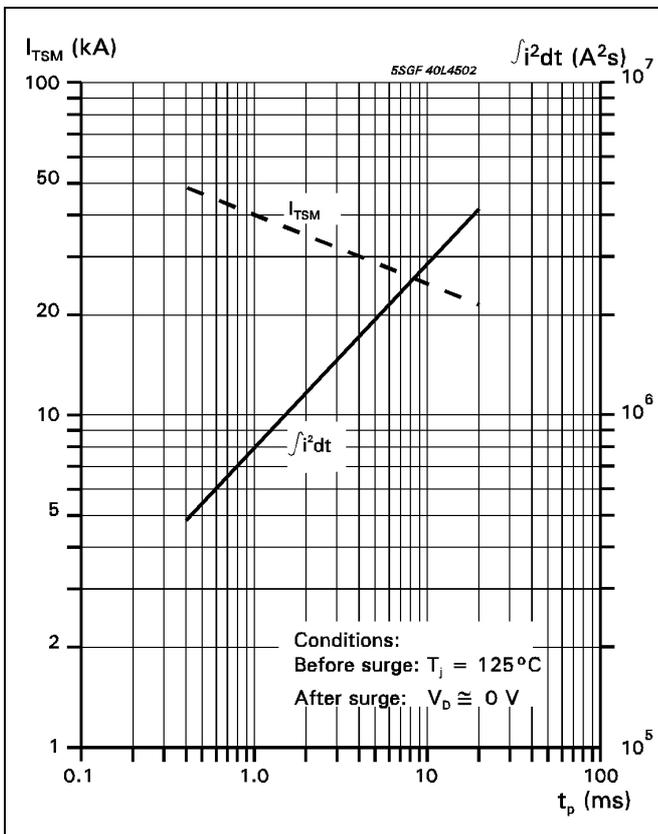


Fig. 4 Surge current and fusing integral vs. pulse width.

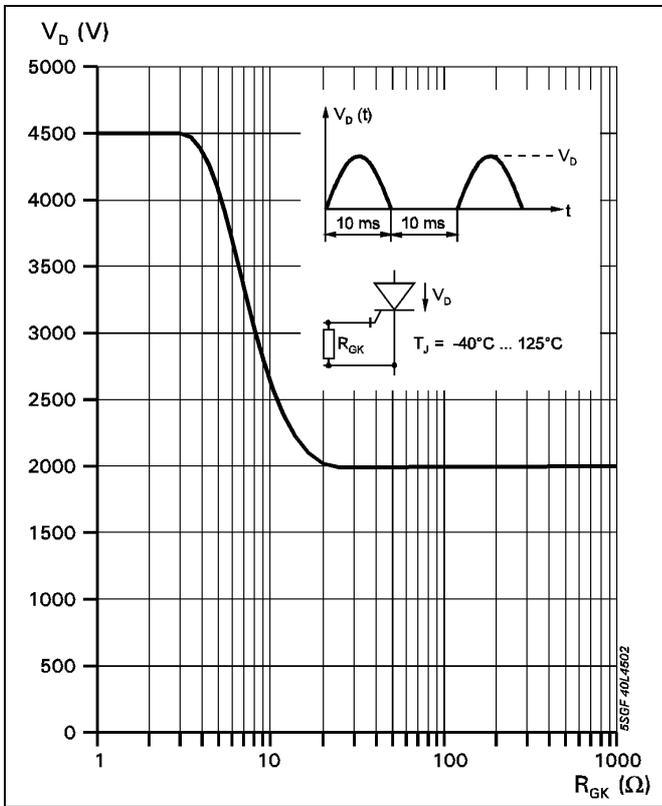


Fig. 5 Forward blocking voltage vs. gate-cathode resistance.

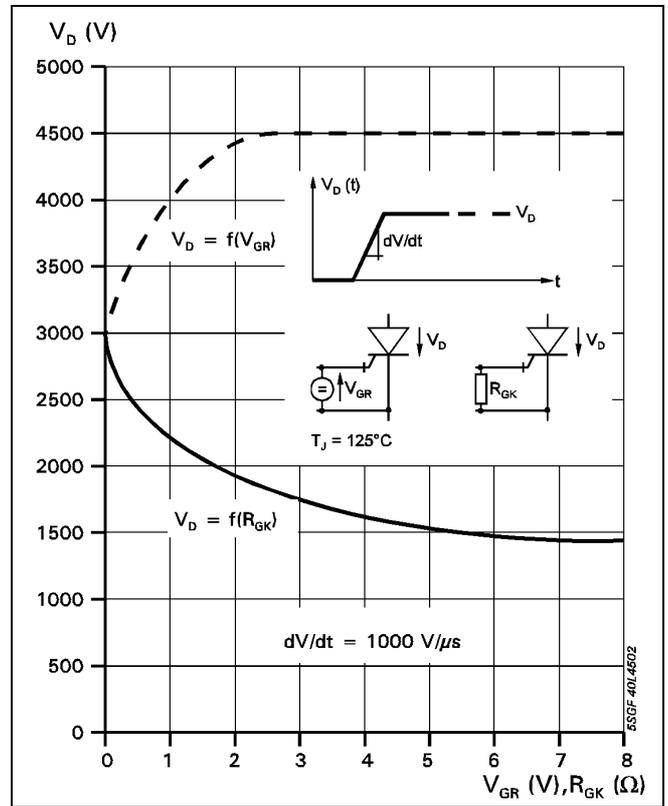


Fig. 6 Static dv/dt capability: Forward blocking voltage vs. neg. gate voltage or gate cathode resistance.

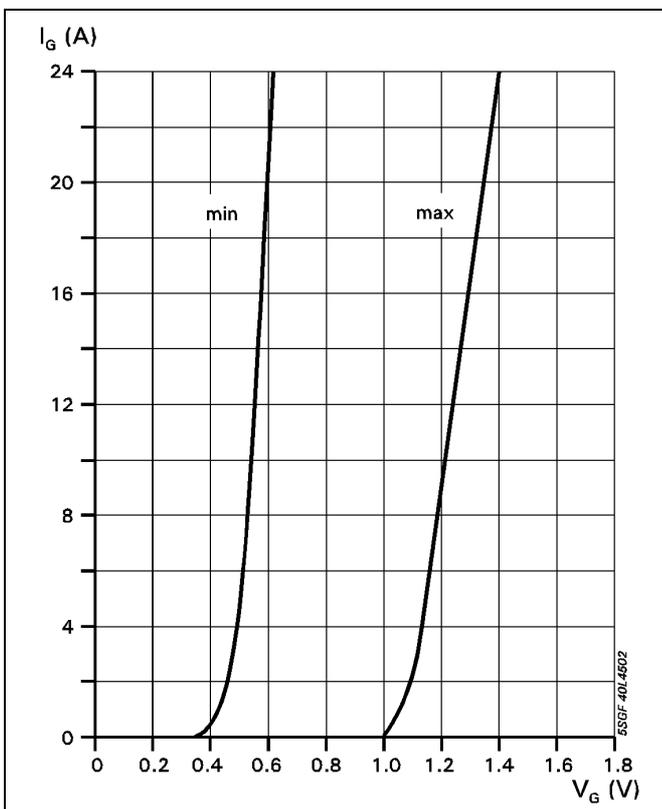


Fig. 7 Forward gate current vs. forward gate voltage.

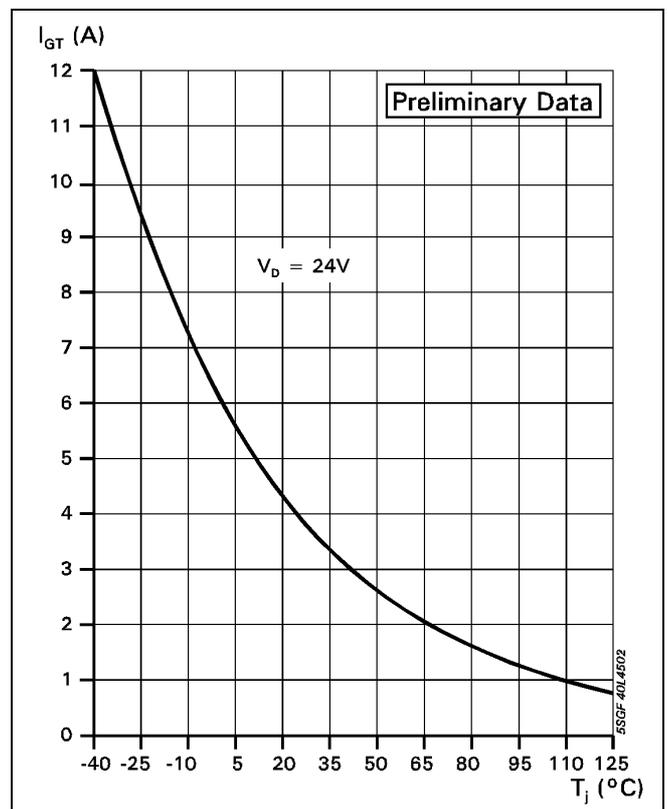


Fig. 8 Gate trigger current vs. junction temperature

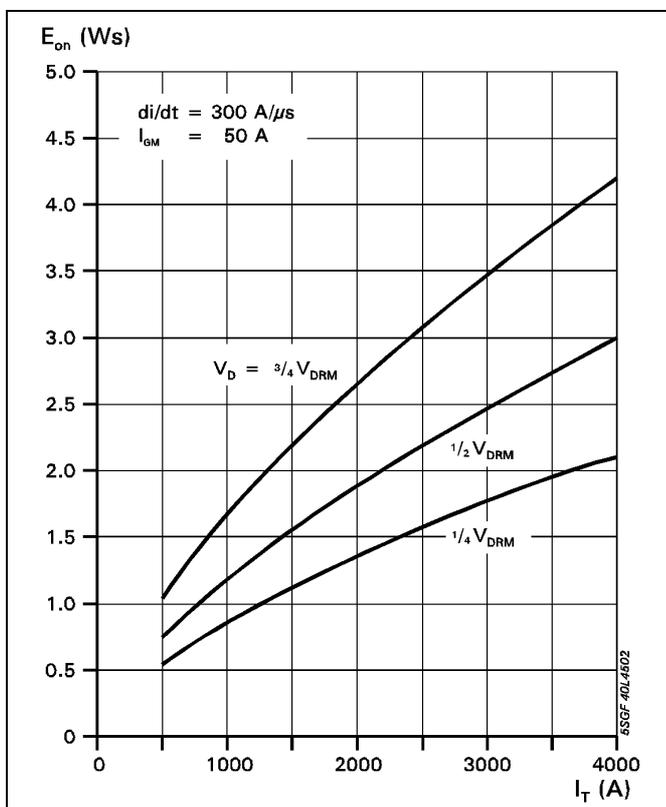


Fig. 9 Turn-on energy per pulse vs. on-state current and turn-on voltage.

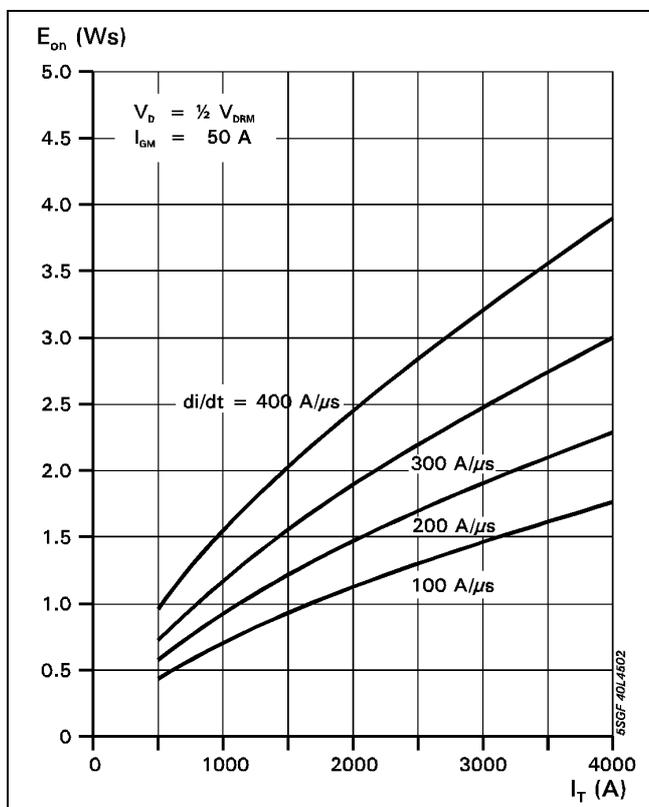


Fig. 10 Turn-on energy per pulse vs. on-state current and current rise rate

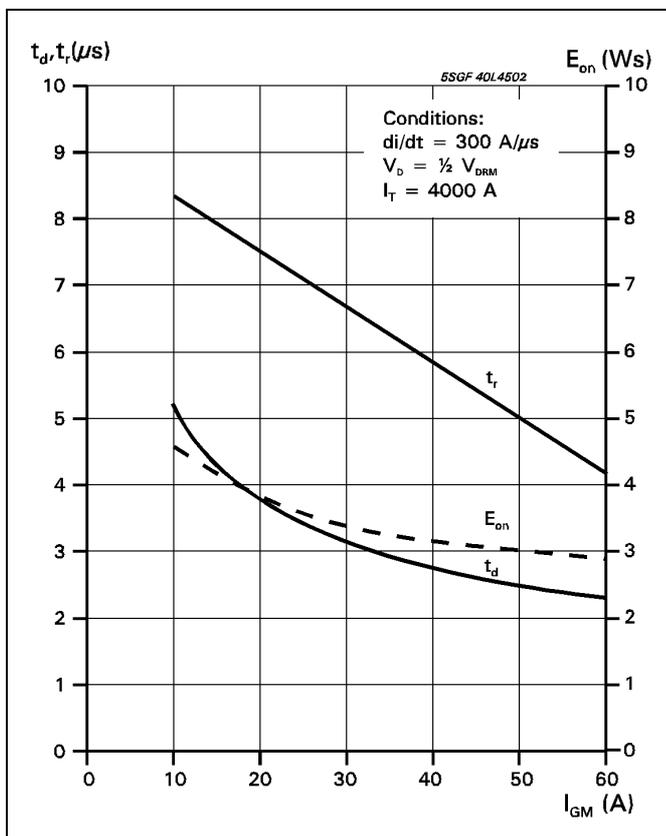


Fig. 11 Turn-on energy per pulse vs. on-state current and turn-on voltage.

Common Test conditions for figures 9, 10 and 11:

- $di_G/dt = 40 \text{ A}/\mu\text{s}$
- $C_S = 6 \mu\text{F}$
- $R_S = 5 \Omega$
- $T_j = 125 \text{ }^\circ\text{C}$

Definition of Turn-on energy:

$$E_{on} = \int_0^{20 \text{ ms}} V_D \cdot I_T dt \quad (t = 0, I_G = 0.1 \cdot I_{GM})$$

Common Test conditions for figures 12, 13 and 15:

Definition of Turn-off energy:

$$E_{off} = \int_0^{40 \text{ ms}} V_D \cdot I_T dt \quad (t = 0, I_T = 0.9 \cdot I_{TQ})$$

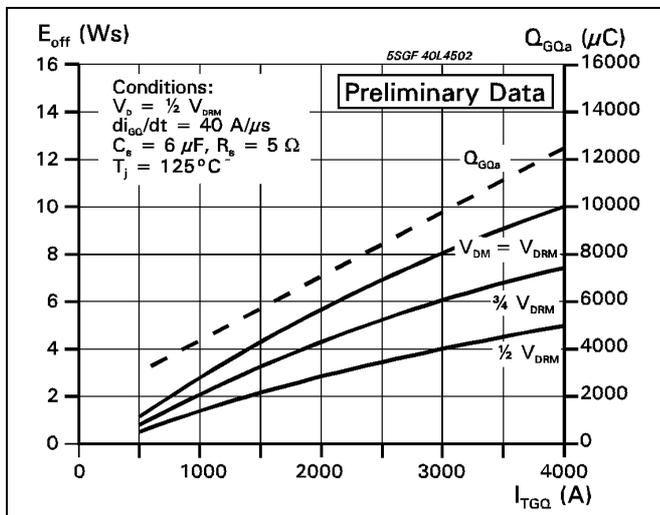


Fig. 12 Turn-off energy per pulse vs. turn-off current and peak turn-off voltage. Extracted gate charge vs. turn-off current.

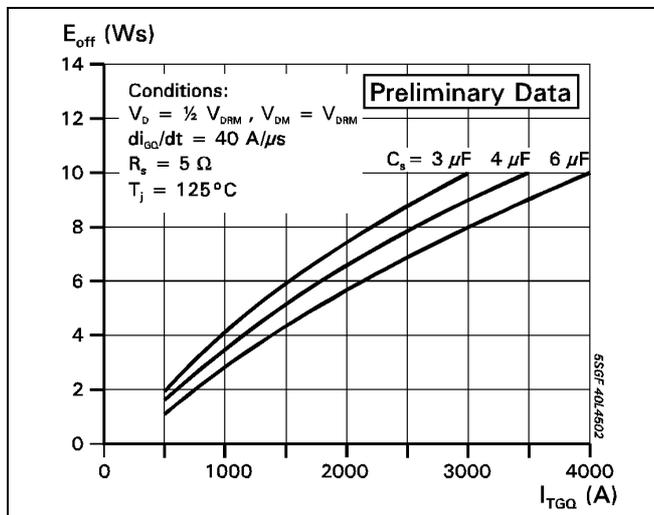


Fig. 13 Turn-off energy per pulse vs. turn-off current and snubber capacitance.

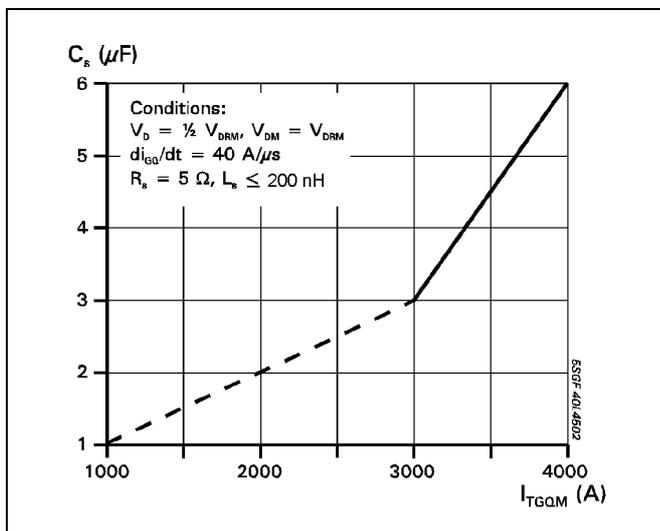


Fig. 14 Required snubber capacitor vs. max allowable turn-off current.

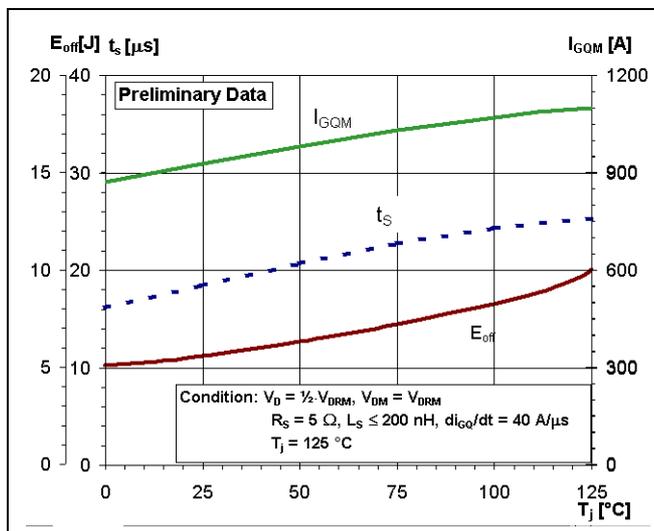


Fig. 15 Turn-off energy per pulse, storage time and peak turn-off gate current vs. junction temperature.

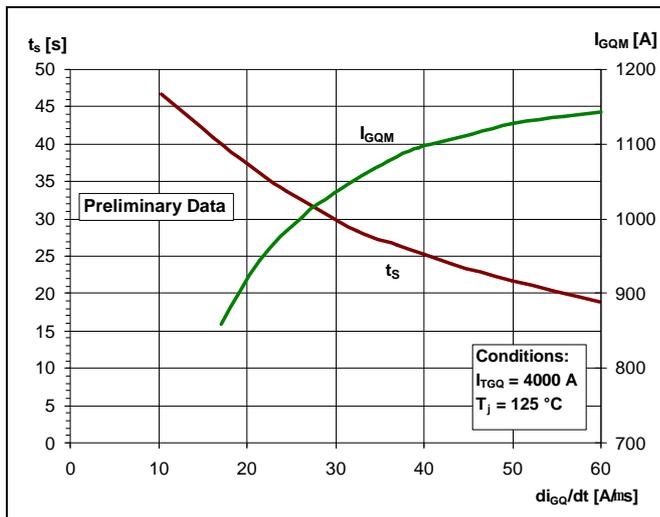


Fig. 16 Storage time and peak turn-off gate current vs. neg. gate current rise rate.

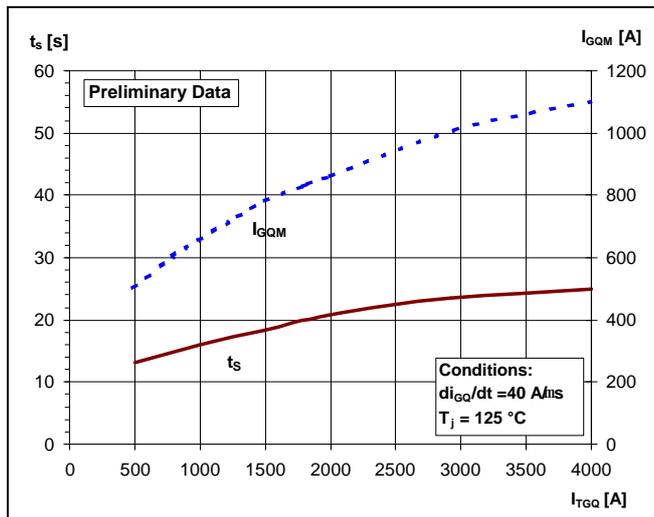


Fig. 17 Storage time and peak turn-off gate current vs. turn-off current.

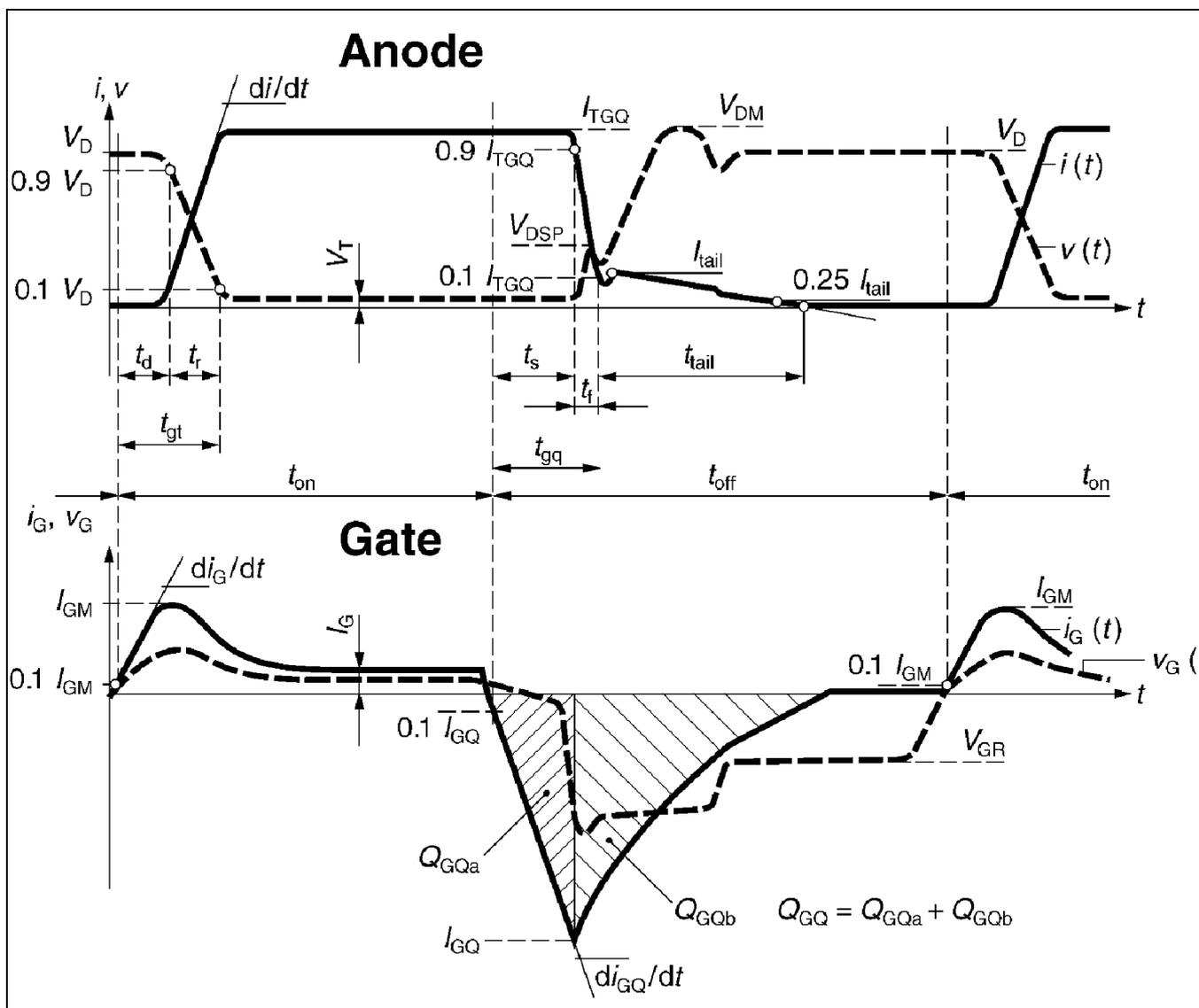


Fig. 18 General current and voltage waveforms with GTO-specific symbols.

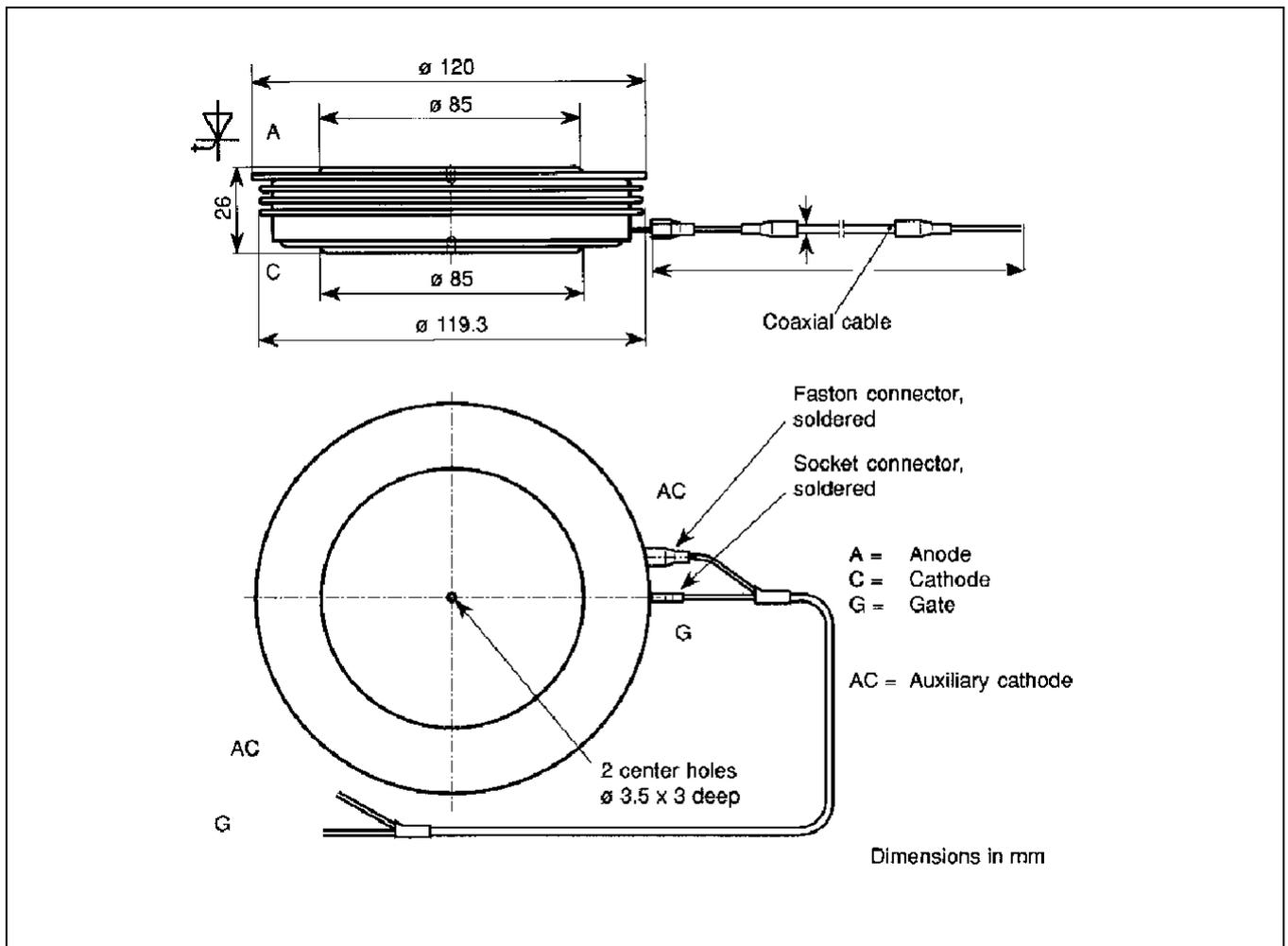


Fig. 19 Outline drawing. All dimensions are in millimeters and represent nominal values unless stated otherwise.

The 5SGF 40L4502 is a 91 mm buffered layer GTO with exceptionally low dynamic and static losses designed to retro-fit all former 4 kA GTOs of the same voltage. It offers optimal trade-off between on-state and switching losses and is encapsulated in an industry-standard press pack housing 120 mm wide and 26 mm thick.

ABB Switzerland Ltd, Semiconductors reserves the right to change specifications without notice.



ABB Switzerland Ltd
Semiconductors
Fabrikstrasse 3
CH-5600 Lenzburg, Switzerland

Telephone +41 (0)58 586 1419
Fax +41 (0)58 586 1306
Email abbsem@ch.abb.com
Internet www.abb.com/semiconductors

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for [SCRs category](#):

Click to view products by [ABB manufacturer](#):

Other Similar products are found below :

[NTE5428](#) [T1500N16TOF VT](#) [T660N22TOF](#) [T720N18TOF](#) [T880N14TOF](#) [T880N16TOF](#) [TT162N16KOF-A](#) [TT162N16KOF-K](#)
[TT330N16AOF](#) [VS-22RIA20](#) [VS-2N685](#) [057219R](#) [T1190N16TOF VT](#) [T1220N22TOF VT](#) [T201N70TOH](#) [T700N22TOF](#) [TT250N12KOF-K](#)
[VS-110RKI40](#) [NTE5427](#) [NTE5442](#) [T2160N28TOF VT](#) [TT251N16KOF-K](#) [VS-22RIA100](#) [VS-16RIA40](#) [TD250N16KOF-A](#) [VS-ST110S16P0](#)
[T930N36TOF VT](#) [T2160N24TOF VT](#) [T1190N18TOF VT](#) [T1590N28TOF VT](#) [2N1776A](#) [T590N14TOF](#) [NTE5375](#) [NTE5460](#) [NTE5481](#)
[NTE5504](#) [NTE5512](#) [NTE5514](#) [NTE5518](#) [NTE5519](#) [NTE5529](#) [NTE5553](#) [NTE5555](#) [NTE5557](#) [NTE5567](#) [NTE5570](#) [NTE5572](#) [NTE5574](#)
[NTE5576](#) [NTE5579](#)